

Kingbright

T-1 3/4 (5mm) SOLID STATE LAMP

Part Number: WP7113SRD5V

Super Bright Red

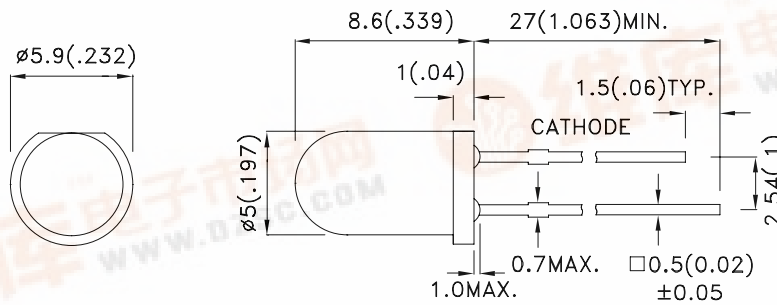
Features

- LOW POWER CONSUMPTION.
- POPULAR T-1 3/4 DIAMETER PACKAGE.
- GENERAL PURPOSE LEADS.
- RELIABLE AND RUGGED.
- LONG LIFE - SOLID STATE RELIABILITY.
- AVAILABLE ON TAPE AND REEL.
- 5V INTERNAL RESISTOR.
- RoHS COMPLIANT.

Description

The Super Bright Red source color devices are made with Gallium Aluminum Arsenide Red Light Emitting Diode.

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01)$ " unless otherwise noted.
3. Lead spacing is measured where the leads emerge from the package.
4. Specifications are subject to change without notice.



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Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] V= 5V		Viewing Angle [1]
			Min.	Typ.	2θ1/2
WP7113SRD5V	Super Bright Red (GaAlAs)	RED DIFFUSED	110	180	30°

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λ_{peak}	Peak Wavelength	Super Bright Red	660		nm	V _F =5V
λ_D [1]	Dominant Wavelength	Super Bright Red	640		nm	V _F =5V
$\Delta\lambda_{1/2}$	Spectral Line Half-width	Super Bright Red	20		nm	V _F =5V
I _F	Forward Current	Super Bright Red	13	17.5	mA	V _F =5V
I _R	Reverse Current	Super Bright Red		10	uA	V _R = 5V

Note:

- 1.Wavelength: +/-1nm.

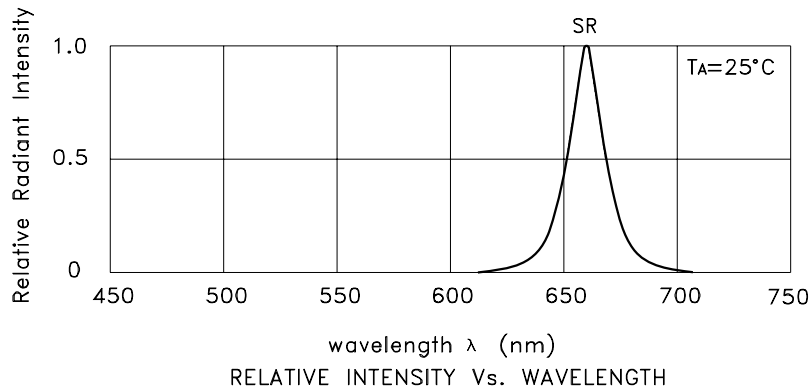
Absolute Maximum Ratings at TA=25°C

Parameter	Super Bright Red	Units
Power dissipation	85	mW
Forward Voltage	6	V
Reverse Voltage	5	V
Operating Temperature	-40°C To +70°C	
Storage Temperature	-40°C To +85°C	
Lead Solder Temperature [1]	260°C For 3 Seconds	
Lead Solder Temperature [2]	260°C For 5 Seconds	

Notes:

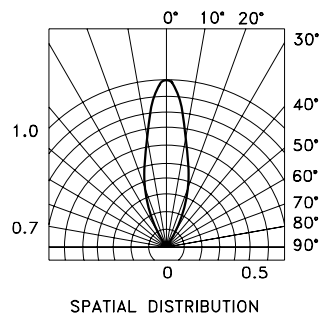
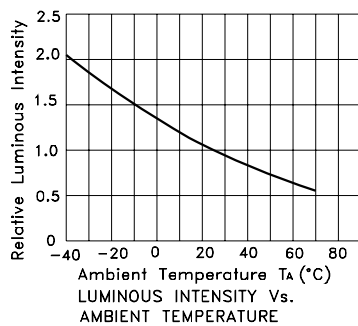
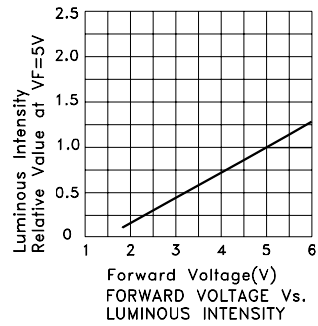
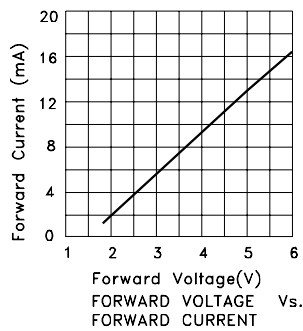
1. 2mm below package base.
2. 5mm below package base.

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Super Bright Red

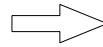
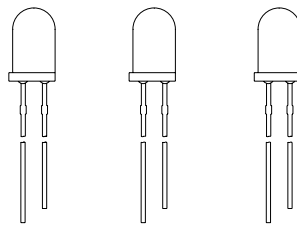
WP7113SRD5V



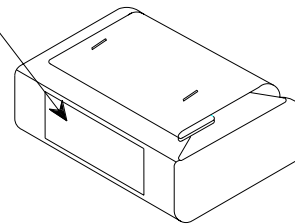
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PACKING & LABEL SPECIFICATIONS

WP7113SRD5V



LABEL

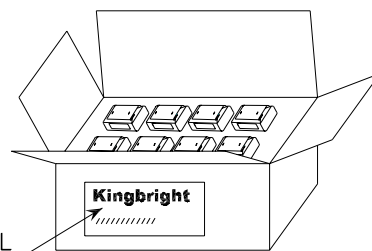
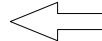


1,000PCS / BAG




36K / 9# BOX

OUTSIDE LABEL



OUTSIDE LABEL

18K / 5# BOX

<h1>Kingbright</h1>				
Q.C.	<table border="1"> <tr> <td>QC</td> </tr> <tr> <td>XX XX XX</td> </tr> <tr> <td>PASSED</td> </tr> </table>	QC	XX XX XX	PASSED
QC				
XX XX XX				
PASSED				
TYPE NO : WP7113xxx				
QUANTITY : 1,000 pcs				
S/N : XX	CODE: XX			
LOT NO : 				
RoHS Compliant				

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LED MOUNTING METHOD

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.

(Fig. 1)

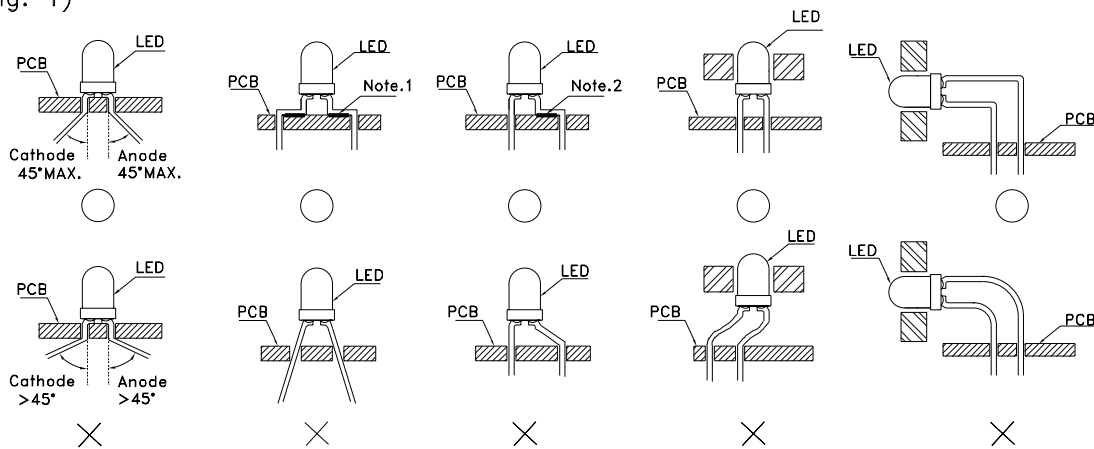


Fig.1

”○” Correct mounting method ”×” Incorrect mounting method

Note 1-2 : Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.

2. When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit.

(Fig. 2)

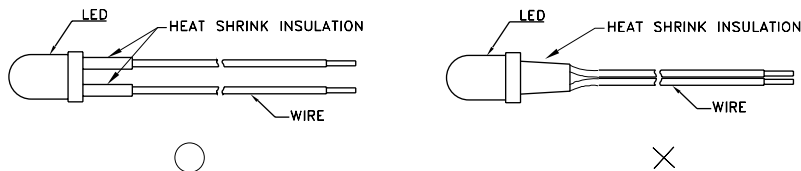


Fig. 2

3. Use stand-offs (Fig. 3) or spacers (Fig. 4) to securely position the LED above the PCB.

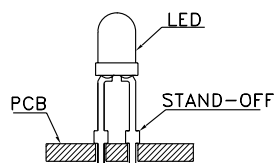


Fig. 3

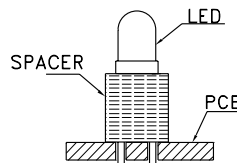


Fig. 4

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LEAD FORMING PROCEDURES

1. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)

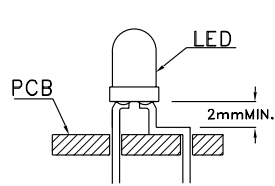


Fig. 5

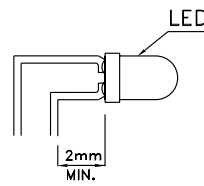


Fig. 6

2. Lead forming or bending must be performed before soldering, never during or after Soldering.
3. Do not stress the LED lens during lead-forming in order to fractures in the lens epoxy and damage the internal structures.
4. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)
5. Do not bend the leads more than twice. (Fig. 8)

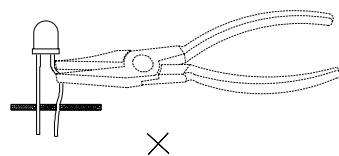


Fig. 7

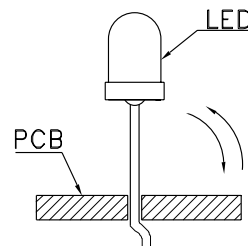


Fig. 8

6. After soldering or other high-temperature assembly, allow the LED to cool down to 50°C before applying outside force (Fig. 9). In general, avoid placing excess force on the LED to avoid damage. For any questions please consult with Kingbright representative for proper handling procedures.

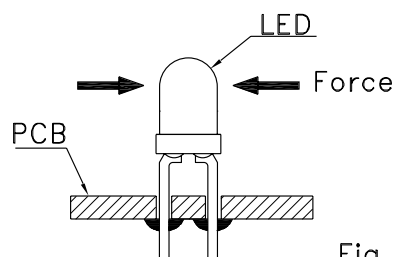


Fig. 9